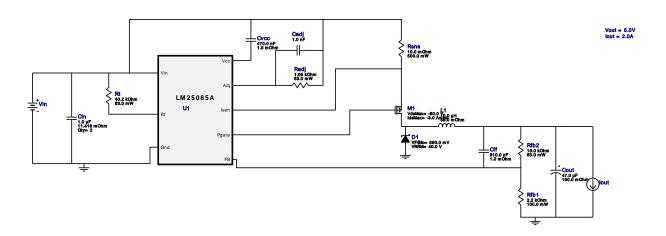
VinMin = 17.0V VinMax = 20.0V Vout = 5.0V Iout = 2.0A Device = LM25085AMY/NOPB Topology = Buck Created = 2023-03-22 05:54:32.317 BOM Cost = \$2.19 BOM Count = 15 Total Pd = 1.46W

# WEBENCH® Design Report

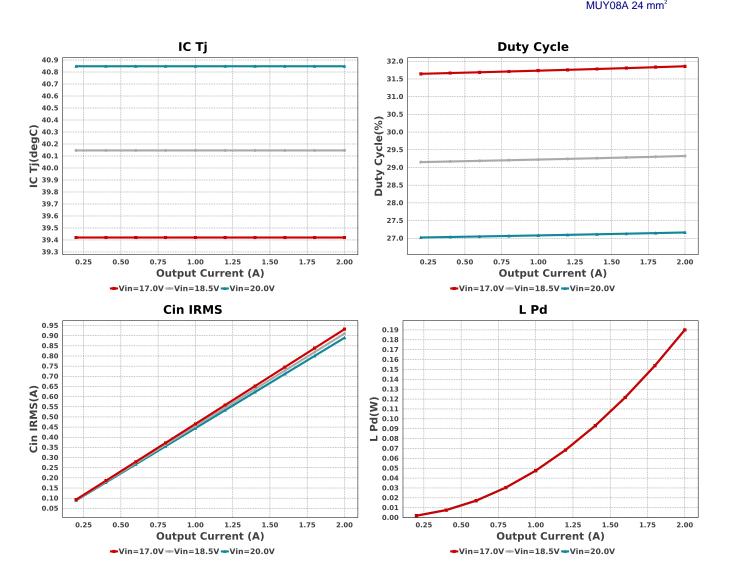
Design: 24 LM25085AMY/NOPB LM25085AMY/NOPB 17V-20V to 5.00V @ 2A

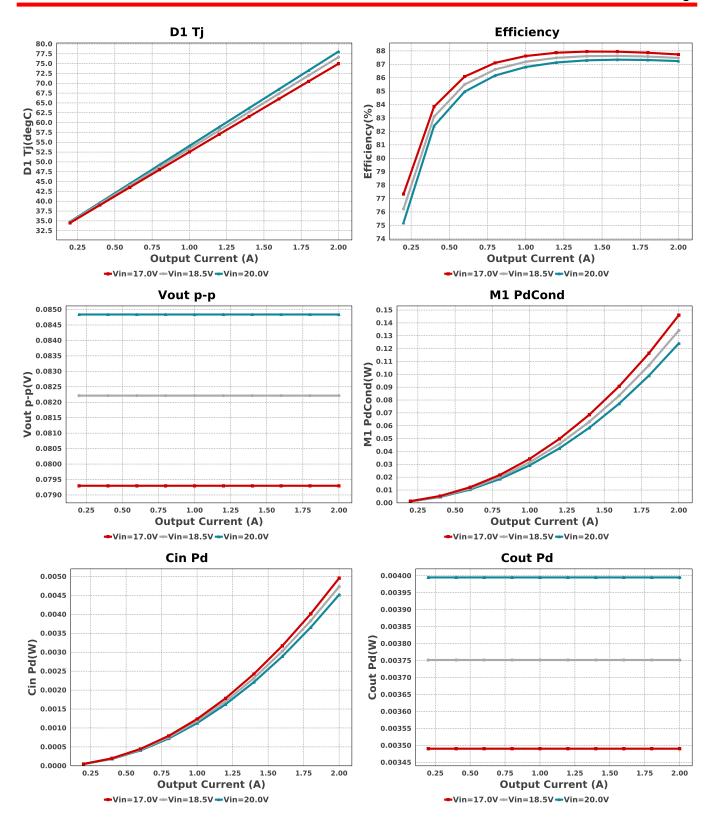


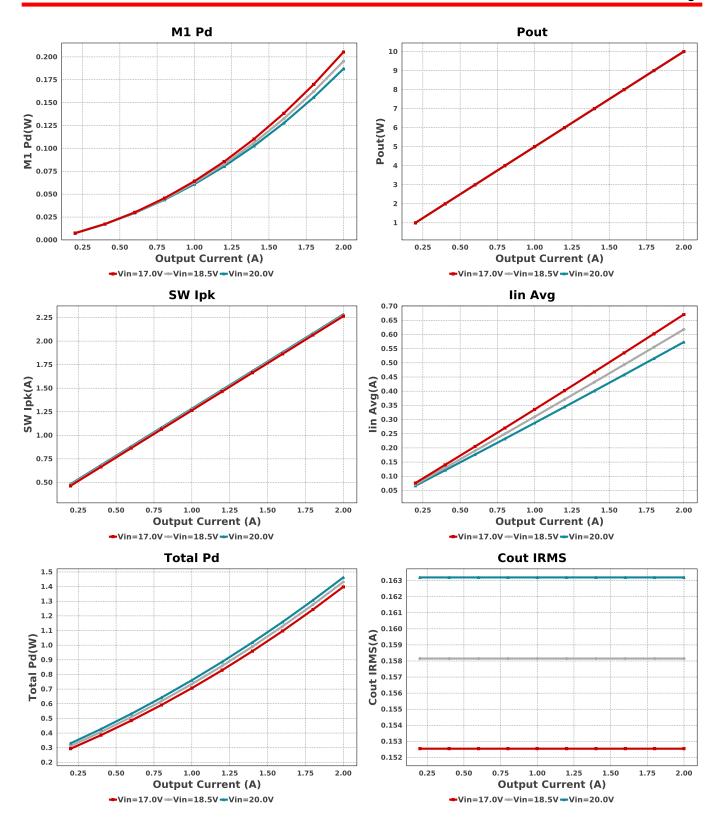
#### **Electrical BOM**

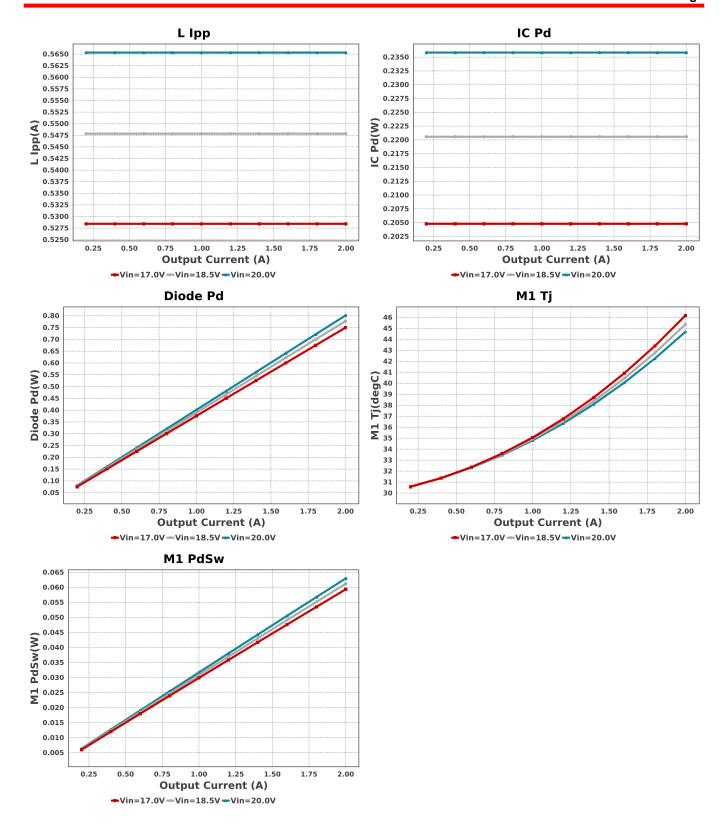
Samsung Electro-	CL21C102JBCNNNC				
Mechanics	Series= C0G/NP0	Cap= 1.0 nF VDC= 50.0 V IRMS= 0.0 A	1	\$0.01	0805 7 mm <sup>2</sup>
Kemet	C0603C911J5GACTU Series= C0G/NP0	Cap= 910.0 pF ESR= 1.0 mOhm VDC= 50.0 V IRMS= 0.0 A	1	\$0.08	0603 5 mm <sup>2</sup>
TDK	C1005X5R1V105K050BC Series= X5R	Cap= 1.0 uF ESR= 11.416 mOhm VDC= 35.0 V IRMS= 1.483 A	2	\$0.03	0402 3 mm <sup>2</sup>
Panasonic	6TPU47MSI Series= TPU	Cap= 47.0 uF ESR= 150.0 mOhm VDC= 6.3 V IRMS= 510.0 mA	1	\$0.44	CAPSMT_6_S09 7 mm <sup>2</sup>
Taiyo Yuden	TMK212BJ474KD-T Series= X5R	Cap= 470.0 nF ESR= 1.0 mOhm VDC= 20.0 V IRMS= 0.0 A	1	\$0.02	0805 7 mm <sup>2</sup>
Fairchild Semiconductor	SS24FL	VF@Io= 550.0 mV VRRM= 40.0 V	1	\$0.09	SOD-123F 12 mm <sup>2</sup>
TDK	VLP8040T-100M	L= 10.0 μH 38.0 mOhm	1	\$0.22	
Enirohild Comingnoductor	EDC5614D	VdoMov- 60.0 V	1	<b>\$0.25</b>	VLP8040 113 mm <sup>2</sup>
FailCillia SeriilCoridactor	PDC3014F	IdsMax= -3.0 Amps	'	φυ.25	SOT-23-6 15 mm <sup>2</sup>
Vishay-Dale	CRCW04021K05FKED Series= CRCWe3	Res= 1.05 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	0402 3 mm <sup>2</sup>
Yageo	RC0603FR-072K2L Series= ?	Res= 2.2 kOhm Power= 100.0 mW Tolerance= 1.0%	1	\$0.01	0603 5 mm <sup>2</sup>
	TDK  Panasonic  Taiyo Yuden  Fairchild Semiconductor  TDK  Fairchild Semiconductor  Vishay-Dale	TDK  C1005X5R1V105K050BC Series= X5R  Panasonic  6TPU47MSI Series= TPU  Taiyo Yuden  TMK212BJ474KD-T Series= X5R  Fairchild Semiconductor  SS24FL  TDK  VLP8040T-100M  Fairchild Semiconductor  FDC5614P  Vishay-Dale  CRCW04021K05FKED Series= CRCWe3  Yageo  RC0603FR-072K2L	Kemet         C0603C911J5GACTU Series= C0G/NP0         Cap= 910.0 pF ESR= 1.0 mOhm VDC= 50.0 V IRMS= 0.0 A           TDK         C1005X5R1V105K050BC Series= X5R         Cap= 1.0 uF ESR= 11.416 mOhm VDC= 35.0 V IRMS= 1.483 A           Panasonic         6TPU47MSI Series= TPU         Cap= 47.0 uF ESR= 150.0 mOhm VDC= 6.3 V IRMS= 510.0 mA           Taiyo Yuden         TMK212BJ474KD-T Series= X5R         Cap= 470.0 nF ESR= 1.0 mOhm VDC= 20.0 V IRMS= 0.0 A           Fairchild Semiconductor         SS24FL         VF@Io= 550.0 mV VRRM= 40.0 V           TDK         VLP8040T-100M         L= 10.0 μH 38.0 mOhm           Fairchild Semiconductor         FDC5614P         VdsMax= -60.0 V IdsMax= -3.0 Amps           Vishay-Dale         CRCW04021K05FKED Series= CRCWe3         Res= 1.05 kOhm Power= 63.0 mW Tolerance= 1.0%           Yageo         RC0603FR-072K2L Series= ?         Res= 2.2 kOhm Power= 100.0 mW	Kemet         C0603C911J5GACTU Series= C0G/NP0         Cap= 910.0 pF ESR= 1.0 mOhm VDC= 50.0 V IRMS= 0.0 A         1           TDK         C1005X5R1V105K050BC Series= X5R         Cap= 1.0 uF ESR= 11.416 mOhm VDC 35.0 V IRMS= 1.483 A         2           Panasonic         6TPU47MSI Series= TPU         Cap= 47.0 uF ESR= 150.0 mOhm VDC= 6.3 V IRMS= 510.0 mA         1           Taiyo Yuden         TMK212BJ474KD-T Series= X5R         Cap= 470.0 nF ESR= 1.0 mOhm VDC= 20.0 V IRMS= 0.0 A         1           Fairchild Semiconductor         SS24FL         VF@lo= 550.0 mV VRRM= 40.0 V         1           TDK         VLP8040T-100M         L= 10.0 μH 38.0 mOhm         1           Vishay-Dale         CRCW04021K05FKED Series= CRCWe3         Res= 1.05 kOhm Power= 63.0 mW Tolerance= 1.0%         1           Yageo         RC0603FR-072K2L Series= ?         Res= 2.2 kOhm Power= 100.0 mW         1	Kemet         C0603C911J5GACTU Series= C0G/NP0         Cap= 910.0 pF ESR= 1.0 mOhm VDC= 50.0 V IRMS= 0.0 A         1         \$0.08           TDK         C1005X5R1V105K050BC Series= X5R         Cap= 1.0 uF ESR= 11.416 mOhm VDC= 35.0 V IRMS= 1.483 A         2         \$0.03           Panasonic         6TPU47MSI Series= TPU         Cap= 47.0 uF ESR= 150.0 mOhm VDC= 6.3 V IRMS= 510.0 mA         1         \$0.44           Taiyo Yuden         TMK212BJ474KD-T ESR= 150.0 mOhm VDC= 20.0 V IRMS= 510.0 mA         1         \$0.02           Fairchild Semiconductor         SS24FL         VF@lo= 550.0 mV VRRM= 40.0 V         1         \$0.09           TDK         VLP8040T-100M         L= 10.0 μH 1 S0.22 S0.0 mV VRRM= 40.0 V         1         \$0.25           Vishay-Dale         CRCW04021K05FKED Series= CRCW.e3         Res= 1.05 KOhm Power= 63.0 mW Tolerance= 1.0%         1         \$0.01           Yageo         RC0603FR-072K2L Series= ?         Res= 2.2 kOhm Power= 100.0 mW         1         \$0.01

Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
Rfb2	Vishay-Dale	CRCW040210K0FKED Series= CRCWe3	Res= 10.0 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	0402 3 mm <sup>2</sup>
Rsns	Stackpole Electronics Inc	CSR1206FK10L0 Series= ?	Res= 10.0 mOhm Power= 500.0 mW Tolerance= 1.0%	1	\$0.11	1206 11 mm <sup>2</sup>
Rt	Vishay-Dale	CRCW040240K2FKED Series= CRCWe3	Res= 40.2 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	0402 3 mm <sup>2</sup>
U1	Texas Instruments	LM25085AMY/NOPB	Switcher	1	\$0.87	MUV08A 24 mm <sup>2</sup>









#### **Operating Values**

		0			
	#	Name	Value	Category	Description
-	1.	Cin IRMS	889.622 mA	Capacitor	Input capacitor RMS ripple current
	2.	Cin Pd	4.518 mW	Capacitor	Input capacitor power dissipation
	3.	Cout IRMS	163.198 mA	Capacitor	Output capacitor RMS ripple current
	4.	Cout Pd	3.995 mW	Capacitor	Output capacitor power dissipation
	5.	D1 Tj	78.071 degC	Diode	D1 junction temperature
	6.	Diode Pd	801.18 mW	Diode	Diode power dissipation
	7.	IC Pd	235.83 mW	IC	IC power dissipation
	8.	IC Tj	40.848 degC	IC	IC junction temperature
	9.	IC Tolerance	18.0 mV	IC	IC Feedback Tolerance
	10.	ICThetaJA	46.0 degC/W	IC	IC junction-to-ambient thermal resistance
	11.	lin Avg	572.95 mA	IC	Average input current

			•	
#	Name	Value	Category	Description
12.	L lpp	565.33 mA	Inductor	Peak-to-peak inductor ripple current
	L Pd	190.0 mW	Inductor	Inductor power dissipation
	M1 Pd	183.58 mW	Mosfet	M1 MOSFET total power dissipation
15.	M1 PdCond	124.45 mW	Mosfet	M1 MOSFET conduction losses
16.	· -	59.128 mW	Mosfet	M1 MOSFET switching losses
	M1 Tj	44.373 degC	Mosfet	M1 MOSFET junction temperature
_	Cin Pd	4.518 mW	Power	Input capacitor power dissipation
_	Cout Pd	3.995 mW	Power	Output capacitor power dissipation
_	Diode Pd	801.18 mW	Power	Diode power dissipation
21.		235.83 mW	Power	IC power dissipation
22.	L Pd	190.0 mW	Power	Inductor power dissipation
23.	M1 Pd	183.58 mW	Power	M1 MOSFET total power dissipation
24.	M1 PdCond	124.45 mW	Power	M1 MOSFET conduction losses
25.	M1 PdSw	59.128 mW	Power	M1 MOSFET switching losses
26.	Total Pd	1.459 W	Power	Total Power Dissipation
27.	BOM Count	15	System	Total Design BOM count
			Information	
28.	Duty Cycle	27.165 %	System	Duty cycle
			Information	
29.	Efficiency	87.267 %	System	Steady state efficiency
			Information	
30.	FootPrint	219.0 mm <sup>2</sup>	System	Total Foot Print Area of BOM components
			Information	·
31.	Frequency	585.631 kHz	System	Switching frequency
			Information	
32.	lout	2.0 A	System	lout operating point
			Information	
33.	Mode	CCM	System	Conduction Mode
			Information	
34.	Pout	10.0 W	System	Total output power
			Information	
35.	SW lpk	2.283 A	System	Peak switch current
	- r		Information	
36.	Total BOM	\$2.19	System	Total BOM Cost
		•	Information	
37.	Vin	20.0 V	System	Vin operating point
			Information	· · · · · · · · · · · · · · · · · · ·
38.	Vout	5.0 V	System	Operational Output Voltage
		0.0 1	Information	oporanonal output voltage
39.	Vout Actual	4.991 V	System	Vout Actual calculated based on selected voltage divider resistors
00.	vout / totaai	4.001 V	Information	Vode / totade odiodiated based on solected voltage divider resistors
40.	Vout Tolerance	3.689 %	System	Vout Tolerance based on IC Tolerance (no load) and voltage divider
₩.	vout rololation	3.000 /0	Information	resistors if applicable
41.	Vout p-p	84.839 mV	System	Peak-to-peak output ripple voltage
<b>→</b> 1.	ν σαι ρ-ρ	UT.000 IIIV	Information	i san to poan output rippio voltage
			miormation	

### **Design Inputs**

Name	Value	Description	
lout	2.0	Maximum Output Current	
VinMax	20.0	Maximum input voltage	
VinMin	17.0	Minimum input voltage	
VinTyp	18.0	Typical input voltage	
Vout	5.0	Output Voltage	
base_pn	LM25085A	Base Product Number	
source	DC	Input Source Type	
Ta	30.0	Ambient temperature	

## WEBENCH® Assembly

#### Component Testing

Some published data on components in datasheets such as Capacitor ESR and Inductor DC resistance is based on conservative values that will guarantee that the components always exceed the specification. For design purposes it is usually better to work with typical values. Since this data is not always available it is a good practice to measure the Capacitance and ESR values of Cin and Cout, and the inductance and DC resistance of L1 before assembly of the board. Any large discrepancies in values should be electrically simulated in WEBENCH to check for instabilities and thermally simulated in WebTHERM to make sure critical temperatures are not exceeded.

#### Soldering Component to Board

If board assembly is done in house it is best to tack down one terminal of a component on the board then solder the other terminal. For surface mount parts with large tabs, such as the DPAK, the tab on the back of the package should be pre-tinned with solder, then tacked into place by one of the pins. To solder the tab town to the board place the iron down on the board while resting against the tab, heating both surfaces simultaneously. Apply light pressure to the top of the plastic case until the solder flows around the part and the part is flush with the PCB. If the solder is not flowing around the board you may need a higher wattage iron (generally 25W to 30W is enough).

#### Initial Startup of Circuit

It is best to initially power up the board by setting the input supply voltage to the lowest operating input voltage 17.0V and set the input supply's current limit to zero. With the input supply off connect up the input supply to Vin and GND. Connect a digital volt meter and a load if needed to set the minimum lout of the design from Vout and GND. Turn on the input supply and slowly turn up the current limit on the input supply. If the voltage starts to rise on the input supply continue increasing the input supply current limit while watching the output voltage. If the current increases on the input supply, but the voltage remains near zero, then there may be a short or a component misplaced on the board. Power down the board and visually inspect for solder bridges and recheck the diode and capacitor polarities. Once the power supply circuit is operational then more extensive testing may include full load testing, transient load and line tests to compare with simulation results.

#### Load Testing

The setup is the same as the initial startup, except that an additional digital voltmeter is connected between Vin and GND, a load is connected between Vout and GND and a current meter is connected in series between Vout and the load. The load must be able to handle at least rated output power + 50% (7.5 watts for this design). Ideally the load is supplied in the form of a variable load test unit. It can also be done in the form of suitably large power resistors. When using an oscilloscope to measure waveforms on the prototype board, the ground leads of the oscilloscope probes should be as short as possible and the area of the loop formed by the ground lead should be kept to a minimum. This will help reduce ground lead inductance and eliminate EMI noise that is not actually present in the circuit.

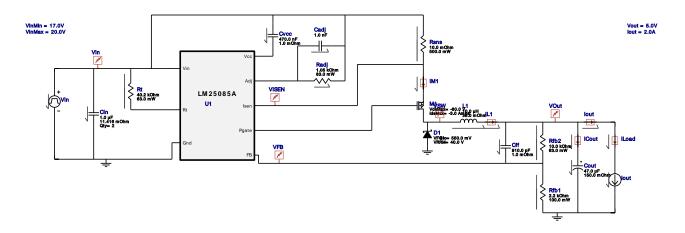


## WEBENCH® Electrical Simulation Report

Design Id = 24

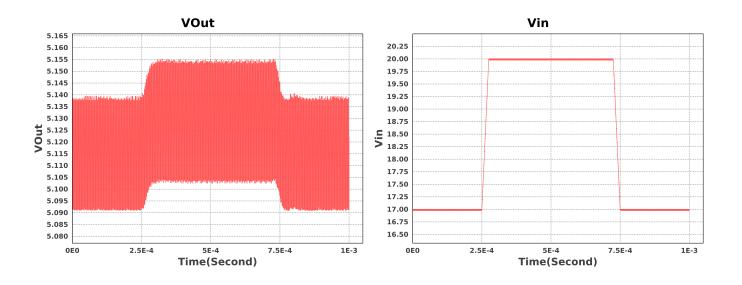
 $sim_id = 3$ 

Simulation Type = Input Transient



#### Simulation Parameters

#	Name	Parameter Name	Description	Values
1.	lout	1	Load Current	2.0 A



#### **Design Assistance**

- 1. For a Constant On Time device to be stable, we need to provide a ripple at the feedback comparator. There are various methods to implement the ripple. Depending on the circuit complexity vs. the allowable ripple, we have three options to choose from. The simplest option, 'Low Complexity', would require only a high ESR cap at the output. This means that the BOM count will be small, but the output voltage ripple will be quite large. The 'optimal solution' would require a feed-forward cap in parallel with the upper feedback resistor to AC couple the ripple to the feedback node. This increases the BOM count slightly, but now we have more control over the output voltage ripple. If the output voltage requirement is very tight, then the best option is to go for the 'Low Output Ripple' solution. In this option we can go with very low ESR output caps and have very good control over the output voltage ripple
- 2. Master key: B9BB535380F6DCECC9D62E6CF388EC6F[v1]
- 3. LM25085A Product Folder: http://www.ti.com/product/LM25085A: contains the data sheet and other resources.

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